

STLVDS47

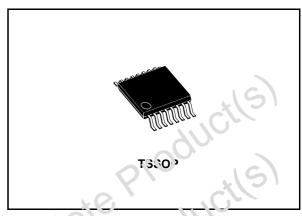
3V LVDS quad cmos differential line driver

Feature summary

- >400 MBPS (200MHz) switching rates
- Flow-through pinout simplifies pcb layout
- 300ps (max.) differential skew
- 1.8 ns (typ.) propagation delay
- 3.3V Power supply design
- ±350 mV Differential signaling
- Low power dissipation (3.5mW at 3.3V static in tristate)
- Interoperable with existing 5V LVDS receivers
- High impedance on LVDS Output on power down
- Conforms to TIA/EIA-644 LVDS standard
- Industrial operating temperature range (-40 °C to +85 °C)
- Available in surface mount (SOIC) ε no νοw profile TSSOP package

Description

The STLVDS47 is a quad CMOS flow-torough differential line driver designed for applications requiring via a low power dissipation and high data rate. The device is designed to support data rates in excess of 400 Viapa (200 MHz) utilizing Lov Voltage Differential Signaling (LVDS) techology.



The STL/CS47 accepts low voltage TTL/CMOS input levels and translated them to low voltage (S50 mV) differential output signals. In addition, the driver support a TRI-STATE function that may be used to disable the output stage, disabling the load current and thus dropping the device to an ultrallow die power state of 1.3mW typical. The STL/DS47 has a flow-through pinout for easy FCB layout.

The EN and EN* inputs are ANDed together and control the TRI-STATE output.

The STLVDS47 and companion line receiver (STLVDS48) provide a new alternative to high power pseudo-ECL devices for high-speed point-to-point interface applications.

Order code

Part n	umber	Temperature Range	Package	Comments
STLVD	S47BTR	-40 to 85 °C	TSSOP16 (Tape & Reel)	2500 parts per reel

April 2006 Rev. 2 1/12

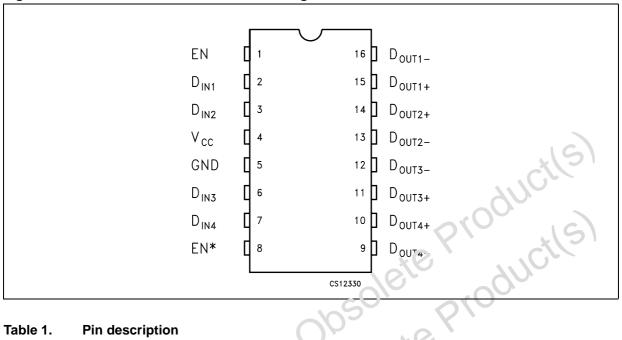
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STLVDS47 Pin configuration

Pin configuration 1

Figure 1. Pin connections and functional diagram



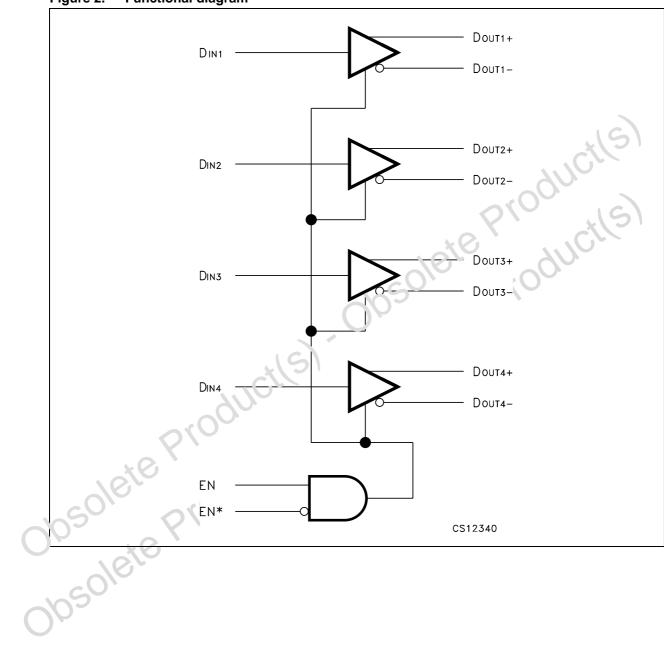
Pin description Table 1.

Pin n°	Symbol	Name and function
1	EN	Enable
2	D _{IN1}	First driver input
3	D _{IN2}	Second driver input
4	V _{CC}	Supply voltage
5	GND	Ground
	D _{IN3}	Third driver input
7	D _{IN4}	Fourth driver input
8 01	EN*	Enable (inverting)
9 (D _{OUT4-}	Fourth driver inverting output
10	D _{OUT4+}	Fourth driver non-inverting output
CO 11	D _{OUT3+}	Third driver non-inverting output
12	D _{OUT3-}	Third driver inverting output
13	D _{OUT2} -	Second driver inverting output
14	D _{OUT2+}	Second driver non-inverting output
15	D _{OUT1+}	First driver non-inverting output
16	D _{OUT1-}	First driver inverting output

Diagram STLVDS47

2 Diagram

Figure 2. Functional diagram



STLVDS47 Maximum ratings

3 Maximum ratings

Table 2. Absolute maximum ratings

		1	1
Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.3 to 4	V
D _{IN}	Input voltage	-0.3 to 6	V
EN, EN*	Enable input voltage	-0.3 to 6	V
D _{OUT+,} D _{OUT-}	Output voltage	-0.3 to 3.9	V
I _{SCTOUT}	Short circuit duration	Continuous	
T _{stg}	Storage temperature range	-65 to +150	S°C

Note:

Absolute Maximum Ratings are those values beyond which damage to tree device may occur. Functional operation under these condition is not implied

Table 3. Recommended operating conditions

	Parameter	Min.	Тур.	Max.	Unit
V _{CC}	Supply voltage	3	3.3	3.6	V
V _{IH}	High-level input voltage	2			V
V _{IL}	Low-level input voltage	10ile		8.0	V
T _A	Operating free-air temperature	-40		85	°C
	ete Product(s)				

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Electrical characteristics STLVDS47

4 Electrical characteristics

Table 4. Electrical characteristics

(Typical values are at T_A = 25°C, V_{CC} = 3.3V ± 10%, T_A = -40 to 85 °C, unless otherwise specified). (Note 1, 2).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{OD1}	Differential output voltage	$R_L = 100 \Omega$	247	350	454	mV
ΔV_{OD1}	Change in magnitude of V _{OD1} for complementary output states		-35		35	mV
V _{oc}	Offset voltage		1.125	1.2	1.375	V
ΔV _{OC}	Change in magnitude of V _{OS} for complementary output states		-25		<u>2</u> ;	mV
I _{IH}	Input high current	V _{IN} = 2V		70	20	μA
I _{IL}	Input low current	V _{IN} = 0.8V	1 C		10	μA
I _{OS}	Output short circuit current (Note 3)	ENABLED, D _{IN} = V _{CC} , D _{OUT+} = 0V or D _{IN} = GND D _{OUT-} = 0V		6	10	mA
I _{OSD}	Differential output short circuit (Note 3)	ENABLED, V _{O(1)} = OV	S C	3	10	mA
I _{OFF}	Power-off leakage	V _{OUT} :: 0V ⊃ı 3.6V, V _{CC} = 0√ or Open			±1	μΑ
I _{OZ}	Output TRI-STATE current	$L^*N = 0.8V$ and $EN^* = 2V$ $V_{OUT} = 0V$ or V_{CC}			±1	μΑ
I _{CCL}	Loaded supply current drivers enabled	$R_L = 100 \Omega$ All Channels, $D_{IN} = V_{CC}$ or GND (all inputs)		18	26	mA
I _{CCZ}	No load supply our ent drivers disabled	$D_{IN} = V_{CC}$ or GND, EN = GND, EN* = V_{CC}		0.4	1	mA

Note:

- Current into device pins is defined as positive. Current out of device pins as negative. All voltage are reference to ground except: V_{OD1} and ΔV_{OD1} .
- 2 The STLVDS47 is a current mode device and only functions within datasheet specifications when a resostive load is applied to the driver outputs typical range is (90 Ω to 110 Ω).
- 3 Output short circuit current (I_{OS}) is specified as magnitude only, minus sign indicates direction only.

Table 5. **Switching characteristics** (Typical values are at T_A = 25°C, V_{CC} = 3.3V \pm 10%, T_A = -40 to 85 °C, unless otherwise specified). (Note 1, 2).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{PLH}	Propagation delay time low-to- high-level output		1.6	1.8	2.7	ns
t _{PHL}	Propagation delay time high-to- low-level output		1.6	1.8	2.7	ns
t _r	Differential output signal rise time	$R_L = 100 \Omega, C_L = 5 pF$		0.5	1	ns
t _f	Differential output signal fall time			0.5	1	ns
t _{SK(p)}	Pulse skew (t _{PHL} - t _{PLH})			100	300	ps
t _{SK(o)}	Channel-to-channel output skew (Note 1)			100	3/10	ps
t _{SK(pp)}	Part-to-part skew (Note 2)		24	20	1	ns
t _{PZH}	Propagation delay time, high- impedance-to-high-level output	. 0.	6.4	5.4	10	ns
t _{PZL}	Propagation delay time, high- impedance-to-low-level output	olete	(7.4	12	ns
t _{PHZ}	Propagation delay time, high- level-to-high-impedance output	0050	6//	3.5	6	ns
t _{PLZ}	Propagation delay time, low- level-to-high-impedance output	1.0 dete		3.9	6	ns
f _{MAX}	Maximum operating frequency	105		250		MHz

- $t_{SK(o)}$ is the magnitude of the time difference between the t_{PLH} or t_{PHL} of all drivers of a single de more with all of their inputs connected together.
- ane time difference between the sum all of their inputs connected together.

 Solve the magnitude of the difference in propagation delignation and two devices when both devices operate with sate magnitude, and have identical packages and test circuits. $t_{S/\sqrt{(i,p)}}$ is the magnitude of the difference in propagation delay times between any specified เลเพิ่มกลls of two devices when both devices operate with same supply voltage, at the same

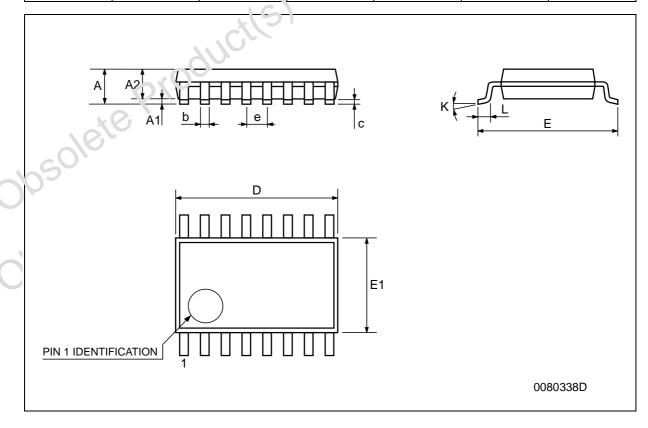
5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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TSSOP16 MECHANICAL DATA

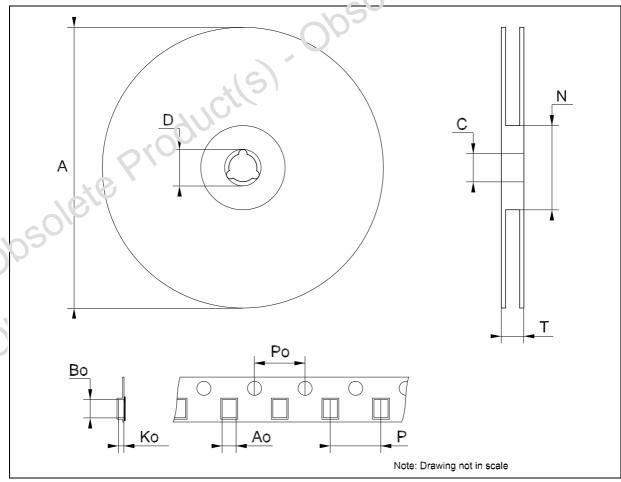
DIM.	mm.			inch			
DIW.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.	
А			1.2			0.047	
A1	0.05		0.15	0.002	0.004	0.006	
A2	0.8	1	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
С	0.09		0.20	0.004		0.0079	
D	4.9	5	5.1	0.193	0.197	0.201	
E	6.2	6.4	6.6	0.244	0.252	0.260	
E1	4.3	4.4	4.48	0.109	0.173	0.176	
е		0.65 BSC		0/0	0.0256 BSC		
К	0°		C° O	0°		8°	
L	0.45	0.60	0.15	0.018	0.024	0.030	



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Tape & R	eel TSSOP16	MECHANICAL	DATA
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DIM		mm.			inch			
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.		
А			330			12.992		
С	12.8		13.2	0.504		0.519		
D	20.2			0.795				
N	60			2.362				
Т			22.4			0.802		
Ao	6.7		6.9	0.264		0.272		
Во	5.3		5.5	0.209	<u> </u>	0.217		
Ko	1.6		1.8	0.063	210	0.071		
Po	3.9		4.1	0.153		0.161		
Р	7.9		8.1	0.311		0.319		



STLVDS47 Revision history

6 Revision history

Table 6. Revision history

Date	Revision	Changes
06-Apr-2006	2	Order codes has been updated and new template.

Obsolete Products). Obsolete Products) Obsolete Products). Obsolete Products).

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